



Vectron's VC-840 Crystal Oscillator (XO) is a quartz stabilized square wave generator with a CMOS output. The VC-840 is a fundamental oscillator resulting in very low jitter performance, and a monolithic IC which improves reliability and reduces cost.

Features

- CMOS output XO
- 1-160.000 MHz Output Frequency
- 1.8, 2.5 or 3.3 V Operation
- Fundamental Crystal Design with low Jitter Performance
- Output Disable Feature
- Small Industry Standard Package, 2.5x2.0mm
- Product is compliant to RoHS directive (1) and fully compatible with lead free assembly

Applications

- SONET/SDH/DWDM
- Ethernet, GE, SynchE
- Storage Area Networking
- Fiber Channel
- Digital Video
- Broadband Access
- Base Stations, Picocells

Block Diagram



Specifications

Parameter	Symbol	Min	Typical	Maximum	Units
		Supply			
Voltage ¹	V _{DD}	3.15	3.3	3.45	V
Maximum Voltage		-0.5		7	V
Current ² , <20.000MHz 20.000-40.000MHz 40.001-60.000MHz 60.001-75.000MHz 75.001-100.000MHz 100.001-130.000MHz 130.001-160.000MHz	I _{DD}			7 13 19 24 25 30 35	mA
Current, Output Disabled				10	uA
· · · · · · · · · · · · · · · · · · ·		Frequency		· · · · ·	
Nominal Frequency	f _N	0.75		160	MHz
Stability ³ , Ordering Information		±	±25, ±50 or ±10	0	ppm
		Outputs			
Output Logic Levels ² Output Logic High Output Logic Low Output Logic High Drive Output Logic Low Drive	V _{oh} V _{ol} I _{oh} I _{ol}	0.9*V _{DD} 4 4		0.1*V _{DD}	V V mA mA
Load	I _{OUT}			15	pF
Output Rise /Fall Time ² , $f_N \le 75$ MHz $f_N > 75$ MHz	t _R /t _F		2.5 2.0	5 3	ns ns
Duty Cycle ² , ⁴		45		55	%
Phase Jitter, 125MHz, 12kHz-20MHz			90	150	fs
Period Jitter⁵ RMS Peak-Peak	Ļφ		1.5 12		ps ps
	Ena	able/Disable		_	
Output Enable/Disable ⁶ Output Enable Output Disable	V _{IH} V _{IL}	0.7*VDD		0.3*VDD	V V
Disable Time				150	ns
Start-Up Time	t _{su}			10	ms
Operating Temp, Ordering Information	Τ _{ορ}	-20/70), -40/85 and -4	10/105	°C

1] The power supply should have by-pass capacitors as close to the supply and to ground as possible, for example 0.1 and 0.01 uF.

2] Parameters are tested with production test circuit below , Figure 1.

3] Includes initial accuracy, operating temperature, supply voltage, shock and vibration (not under operation) and aging

4] Duty Cycle is measured as On Time/Period (Fig 2).

5] Broadband Period Jitter measured using LeCroy Waverunner 610Zi, 200k minimum samples

6] The Output is Enabled if the Enable/Disable is left open.





Fig 1: Test Circuit

Specifications

Parameter	Symbol	Min	Typical	Maximum	Units
		Supply	:		
Voltage ¹	V _{DD}	2.375	2.5	2.625	V
Maximum Voltage		-0.5		7	V
Current ² , <20.000MHz 20.000-40.000MHz 40.001-60.000MHz 60.001-75.000MHz 75.001-100.000MHz 100.001-130.000MHz 130.001-160.000MHz	I _{DD}			5 9 11 14 20 25 30	mA
Current, Output Disabled				10	uA
		Frequency			
Nominal Frequency	f _N	0.75		160	MHz
Stability ³ , Ordering Information		-	0	ppm	
		Outputs			
Output Logic Levels ² Output Logic High Output Logic Low Output Logic High Drive Output Logic Low Drive	V _{oh} V _{ol} I _{oh} I _{ol}	0.9*V _{DD} 4 4		0.1*V _{DD}	V V mA mA
Load	I _{OUT}			15	pF
Output Rise /Fall Time² f _N ≤ 75MHz f _N > 75MHz	t _R /t _F		2.5 2	5 3	ns ns
Duty Cycle ² , ⁴		40		60	%
Phase Jitter, 125MHz, 12kHz-20MHz			100	170	fs
Period Jitter⁵ RMS Peak-Peak	φ		1.5 12		ps ps
	Ena	able/Disable			
Output Enable/Disable ⁶ Output Enable Output Disable	V _{IH} V _{IL}	0.7*VDD		0.3*VDD	V V
Disable Time				150	ns
Start-Up Time	t _{su}			10	ms
Operating Temp, Ordering Information	T _{OP}	-20/7	0, -40/85 and -4	40/105	°C

1] The power supply should have by-pass capacitors as close to the supply and to ground as possible, for example 0.1 and 0.01 uF.

2] Parameters are tested with production test circuit below , Figure 1.

3] Includes initial accuracy, operating temperature, supply voltage, shock and vibration (not under operation) and aging

4] Duty Cycle is measured as On Time/Period (Fig 2).

5] Broadband Period Jitter measured using LeCroy Waverunner 610Zi, 200k minimum samples

6] The Output is Enabled if the Enable/Disable is left open.





Specifications

Table 3. Electrical Performance, 1.8V option								
Parameter	Symbol	Min	Typical	Maximum	Units			
Supply								
Voltage ¹	V _{DD}	1.71	1.8	1.89	V			
Maximum Voltage		-0.5		7	V			
Current ² , <20.000MHz 20.000-40.000MHz 40.001-50.000MHz 50.001-75.000MHz 75.001-100.000MHz 100.001-130.000MHz	I _{DD}			2.5 3.0 3.5 10 15 20	mA			
Current, Output Disabled				10	uA			
		Frequency						
Nominal Frequency	f _N	0.75		125	MHz			
Stability ³ , Ordering Information		=	±25, ±50 or ±10	0	ppm			
	<u>^</u>	Outputs						
Output Logic Levels ² Output Logic High Output Logic Low Output Logic High Drive Output Logic Low Drive	V _{oh} V _{ol} I _{oh} I _{ol}	0.9*V _{DD} 4 4		0.1*V _{DD}	V V mA mA			
Load	I _{OUT}			15	pF			
Output Rise /Fall Time²f _N ≤ 75MHz f _N > 75MHz	t _R /t _F		2.5 2	5 3	ns ns			
Duty Cycle ² , ⁴		45		55	%			
Phase Jitter, 125MHz, 12kHz-20MHz			150	225	fs			
Period Jitter⁵ RMS Peak-Peak	φJ		1.5 12		ps ps			
	Ena	able/Disable						
Output Enable/Disable ⁶ Output Enable Output Disable	V _{IH} V _{IL}	0.7*VDD		0.3*VDD	V V			
Disable Time				150	ns			
Start-Up Time	t _{su}			10	ms			
Operating Temp, Ordering Information	Τ _{ορ}	-20,	/70, -40/85, -40,	/105	°C			

1] The power supply should have by-pass capacitors as close to the supply and to ground as possible, for example 0.1 and 0.01uF.

2] Parameters are tested with production test circuit below , Figure 1.

3] Includes initial accuracy, operating temperature, supply voltage, shock and vibration (not under operation) and aging

4] Duty Cycle is measured as On Time/Period (Fig 2).

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Fig 6: Waveform

Outline Drawing & Pad Layout



Reliability

Vectron qualification includes aging at various extreme temperatures, shock and vibration, temperature cycling, and IR reflow simulation. The VC-840 family is capable of meeting the following qualification tests:

Table 6. Environmental Compliance						
Parameter	Conditions					
Mechanical Shock	MIL-STD-883, Method 2002					
Mechanical Vibration	MIL-STD-883, Method 2007					
Solderability	MIL-STD-883, Method 2003					
Gross and Fine Leak	MIL-STD-883, Method 1014					
Resistance to Solvents	MIL-STD-883, Method 2015					
Moisture Sensitivity Level	MSL 1					
Contact Pads	Gold (0.3 um min to 1.0 um max) over Nickel					

Although ESD protection circuitry has been designed into the VC-840 proper precautions should be taken when handling and mounting. Vectron employs a human body model (HBM) and a charged device model (CDM) for ESD susceptibility testing and design protection evaluation.

Table 7. ESD Ratings							
Model	Minimum	Conditions					
Human Body Model	1500V	MIL-STD-883, Method 3015					
Charged Device Model	1000V	JESD22-C101					

Stresses in excess of the absolute maximum ratings can permanently damage the device. Functional operation is not implied at these or any other conditions in excess of conditions represented in the operational sections of this datasheet. Exposure to absolute maximum ratings for extended periods may adversely affect device reliability. Permanent damage is also possible if E/D is applied before V_{DD}.

Table 8. Absolute Maximum Ratings							
Parameter	Symbol	Ratings	Unit				
Storage Temperature	Τ _s	-55 to 100	°C				
Soldering Temp/Time	T _{LS}	260 / 10	°C / sec				

IR Reflow

Solderprofile:

The VC-840 is qualified to meet the JEDEC standard for Pb-Free assembly. The temperatures and time intervals listed are based on the Pb-Free small body requirements. The VC-840 device is hermetically sealed so an aqueous wash is not an issue.



Table 9. Reflow Profile							
Parameter	Symbol	Value					
PreHeat Time Ts-min Ts-max	t _s	60 sec Min, 260 sec Max 150℃ 200℃					
Ramp Up	R _{UP}	3 °C/sec Max					
Time Above 217 °C	t	60 sec Min, 150 sec Max					
Time To Peak Temperature	T _{AMB-P}	480 sec Max					
Time at 260 °C	t _P	30 sec Max					
Ramp Down	R _{DN}	6 °C/sec Max					

Tape and Reel

Table 10 . Tape and Reel Dimensions												
Tape Dimensions (mm)								Reel Di	mensior	ıs (mm)		
Dimension	W	F	Do	Ро	P1	Α	В	С	D	Ν	W1	W2
Tolerance	Тур	Тур	Тур	Тур	Тур	Тур	Min	Тур	Min	Min	Тур	Max
VC-840	8.0	3.5	1.5	4.0	4.0	180	2.0	13.0	21.0	60.0	9	11.4





Note: Not all combinations of options are available. Other specifications may be available upon request. Consult with factory.

Example: VC-840-EAE-KAAN-25M000000TR Ta VC-840-EAE-KAAN-25M0000000 Cu VC-840-EAE-KAAN-25M0000000_SNPB Tin

Tape and Reel Cut Tape Tin lead solder dipped

Revision History							
Revision Date	Edited	Approved	Description				
May 14, 2014	VN	TG	Corrected Operating Temperature in Specification Tables 1, 2 and 3 to show -20/70°C Removed Standard Output Frequencies Table 10 (Empty)				
Aug 4, 2015	EM	DL	Added temp range -40/105°C and note in RED on page 7				
Aug 16, 2015	EM	DL	Updated Rise/Fall time				
Jan 17, 2017	RC	RC	Update IR Reflow Table				
Aug 10, 2018	FB	FB	Update logo and contact information, added SNPBDIP ordering option				
March 30, 2019	FB	YM	Update logo, add gold thickness, add phase jitter, update SNPBDIP to SNPB				
April 30, 2020	FB	YM	Add tape and reel ordering option, updates and corrections as needed				

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